PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data		
1.1 Company STMicroelectronics International N.V		STMicroelectronics International N.V
1.2 PCI No.		AMS/21/13073
1.3 Title of PCI		Second source introduction on Carrier tape for devices with package SO16L
1.4 Product Category		See product list
1.5 Issue date		2021-11-05

2. PCI Team		
2.1 Contact supplier		
2.1.1 Name	NEMETH KRISZTINA	
2.1.2 Phone	+49 89460062210	
2.1.3 Email	krisztina.nemeth@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Domenico ARRIGO,Marcello SAN BIAGIO	
2.1.2 Marketing Manager	Fulvio PULICELLI,Salvatore DI VINCENZO	
2.1.3 Quality Manager	Alessandro PLATINI, Giuseppe LISI, Jean-Marc BUGNARD	

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	Change of qualified supplier providing the same part number for indirect material (e.g. blade, ejector, capillary, window clamp, cropping punch, etc)	ST SHENZHEN (CHINA)

4. Description of change		
	Old	New
4.1 Description	Carrier tape supplier : - CPAK	Carrier tape supplier : - CPAK - 3M
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change	
5.1 Motivation	To secure supply chain
5.2 Customer Benefit	DOUBLE SOURCING

6. Marking of parts / traceability of change	
6.1 Description	N/A

7. Timing / schedule		
7.1 Date of qualification results	2021-12-15	
7.2 Intended start of delivery	2021-12-15	
7.3 Qualification sample available?	Not Applicable	

8. Qualification / Validation			
8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)

13073 Public product.pdf

10. Affected parts		
	10. 1 Current	10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	L6563HTR	
	L6563STR	
	L6599ADTR	
	M74HC4094YRM13TR	
ST232BDR	ST232BDR	
ST232CDR	ST232CDR	
	STDRIVEG600TR	
	ULN2003D1013TR	
	ULN2004D1013TR	
	VIPER0PLDTR	

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